

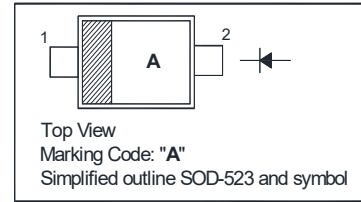
# BAS316WT-AH

## Silicon Epitaxial Planar Switching Diode

PIN	DESCRIPTION
1	Cathode
2	Anode

### Features

- AEC-Q101 Qualified
- Halogen and Antimony Free(HAF), RoHS compliant



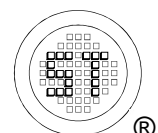
### Absolute Maximum Ratings ( $T_a = 25\text{ }^\circ\text{C}$ )

Parameter	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	$V_{RRM}$	100	V
Reverse Voltage	$V_R$	100	V
Continuous Forward Current	$I_F$	250	mA
Repetitive Peak Forward Current	$I_{FRM}$	500	mA
Non-Repetitive Peak Forward Current	$I_{FSM}$	4 1 0.5	A
Power Dissipation	$P_D$	150 500	mW
Junction Temperature	$T_j$	150	$^\circ\text{C}$
Storage Temperature Range	$T_{stg}$	- 65 to + 150	$^\circ\text{C}$

### Thermal Characteristics

Parameter	Symbol	Max.	Unit
Thermal Resistance from Junction to Ambient <sup>1)</sup>	$R_{\theta JA}$	833	$^\circ\text{C/W}$

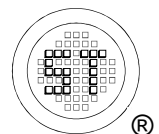
<sup>1)</sup> Device mounted on FR-4 PCB with minimum recommended pad layout.



# BAS316WT-AH

## Characteristics at $T_a = 25\text{ }^\circ\text{C}$

Parameter	Symbol	Max.	Unit
Forward Voltage at $I_F = 1\text{ mA}$ at $I_F = 10\text{ mA}$ at $I_F = 50\text{ mA}$ at $I_F = 150\text{ mA}$	$V_F$	0.715 0.855 1 1.25	V
Reverse Current at $V_R = 25\text{ V}$ at $V_R = 75\text{ V}$ at $V_R = 25\text{ V}, T_J = 150\text{ }^\circ\text{C}$ at $V_R = 75\text{ V}, T_J = 150\text{ }^\circ\text{C}$	$I_R$	30 1 30 50	nA $\mu\text{A}$ $\mu\text{A}$ $\mu\text{A}$
Diode Capacitance at $V_R = 0\text{ V}, f = 1\text{ MHz}$	$C_{\text{tot}}$	1.5	pF
Reverse Recovery Time at $I_F = 10\text{ mA}, V_R = 6\text{ V}, I_{\text{rr}} = 0.1 \times I_R, R_L = 100\ \Omega$	$t_{\text{rr}}$	4	ns



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## Electrical Characteristics Curves

Fig 1. Power Derating Curve

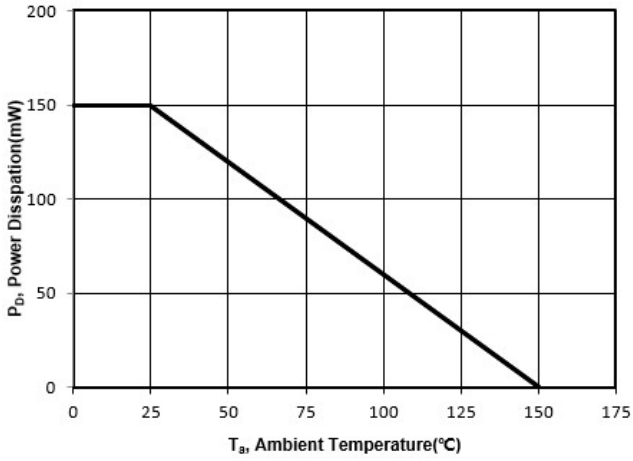


Fig 2. Total Capacitance vs. Reverse Voltage

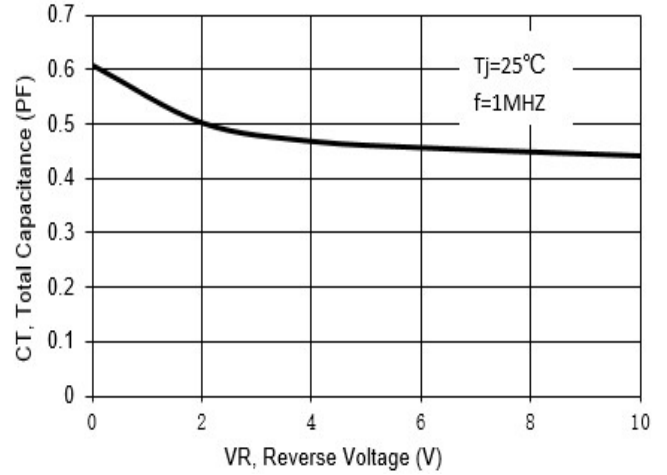


Fig 3. Reverse Current vs. Reverse Voltage

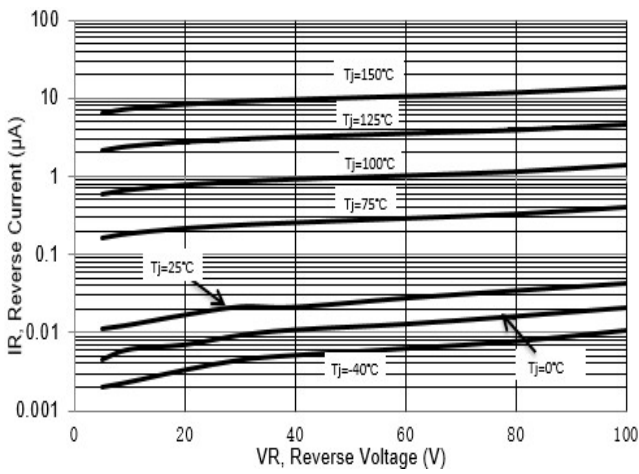
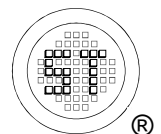
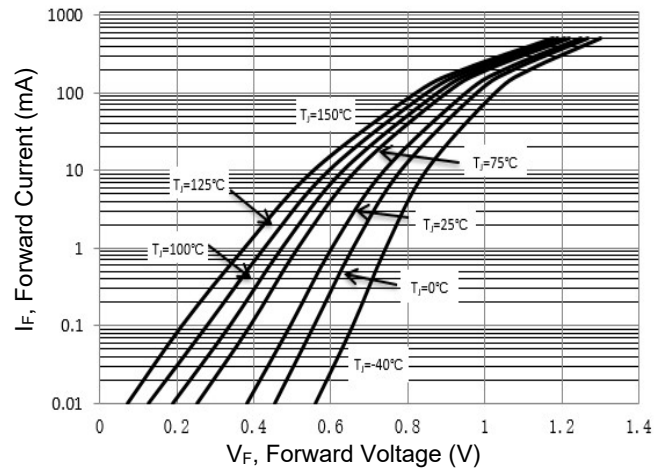


Fig 4. Forward Characteristics

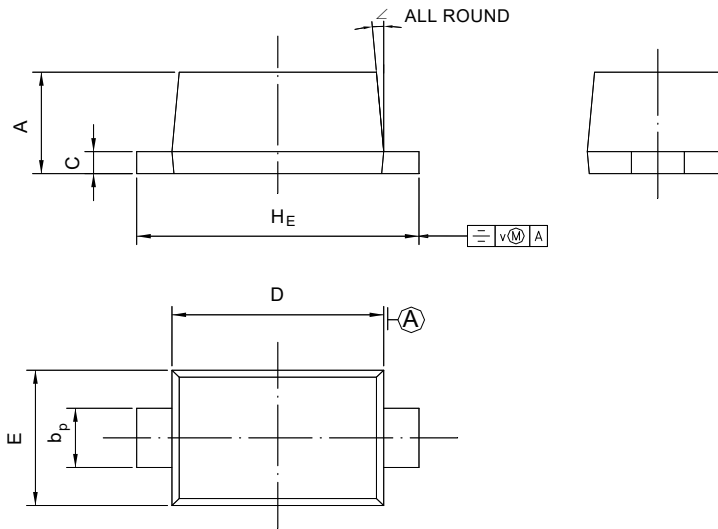


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## PACKAGE OUTLINE

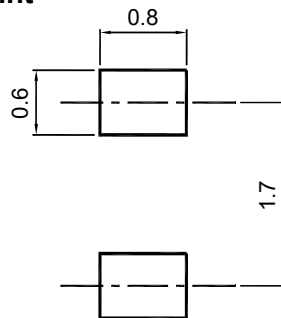
Plastic surface mounted package; 2 leads

SOD-523



UNIT	A	b <sub>p</sub>	C	D	E	H <sub>E</sub>	V	∠
mm	0.70 0.60	0.4 0.3	0.135 0.100	1.25 1.15	0.85 0.75	1.7 1.5	0.1	5°

### Recommended Soldering Footprint



### Packing information

Package	Tape Width (mm)	Pitch		Reel Size		Per Reel Packing Quantity
		mm	inch	mm	inch	
SOD-523	8	4 ± 0.1	0.157 ± 0.004	178	7	4,000

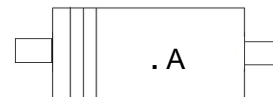
### Marking information

" III " = Cathode line

" • " = HAF (Halogen and Antimony Free)

" A " = Part No.

Font type: Arial



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